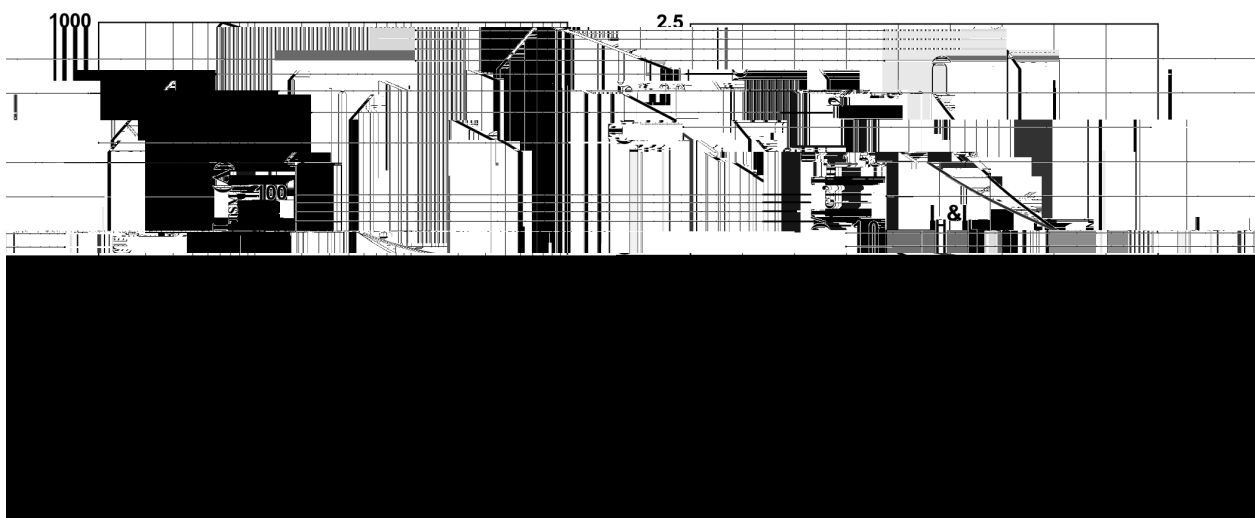
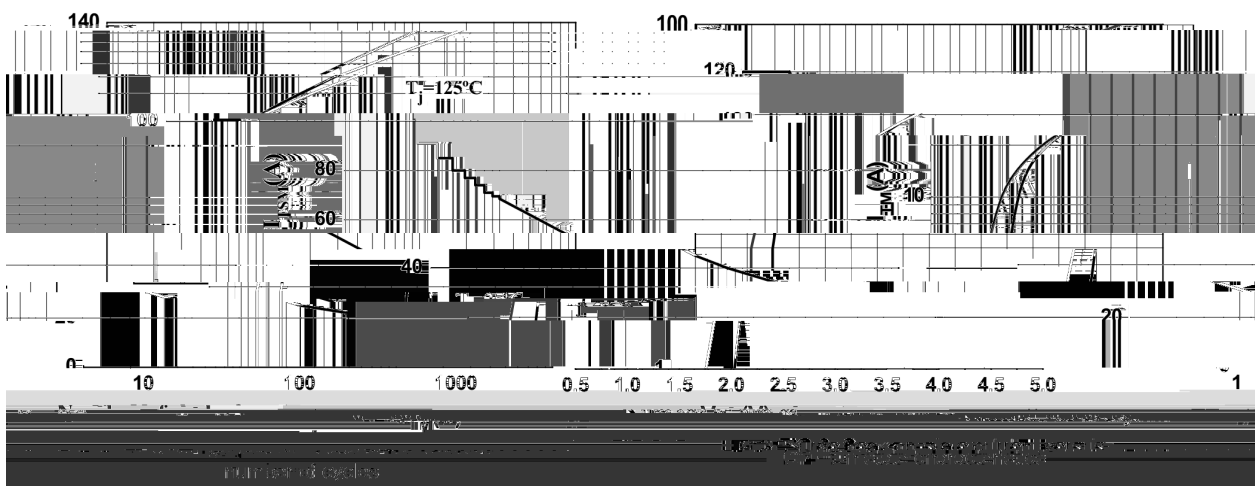
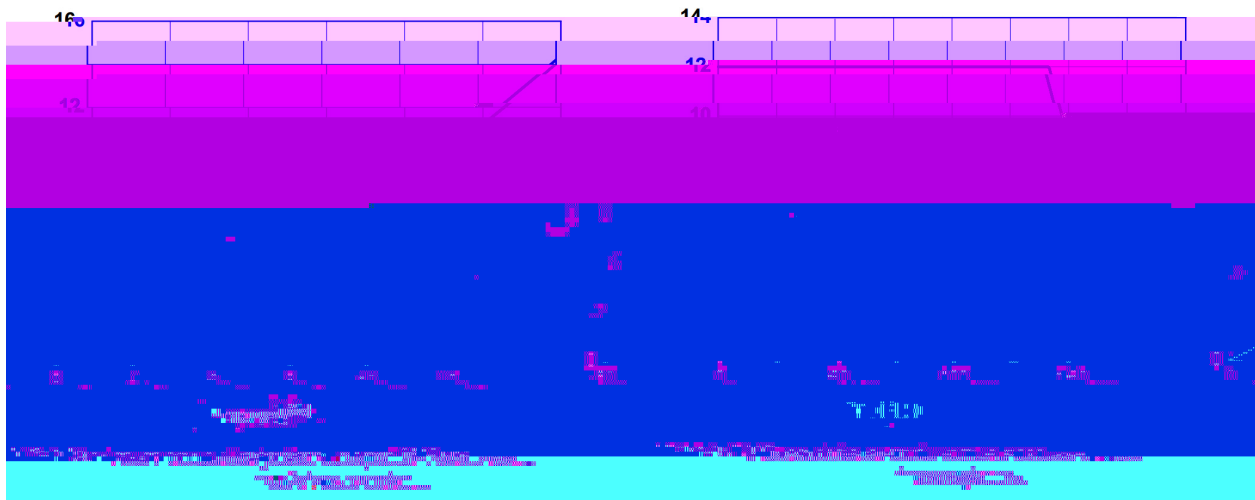
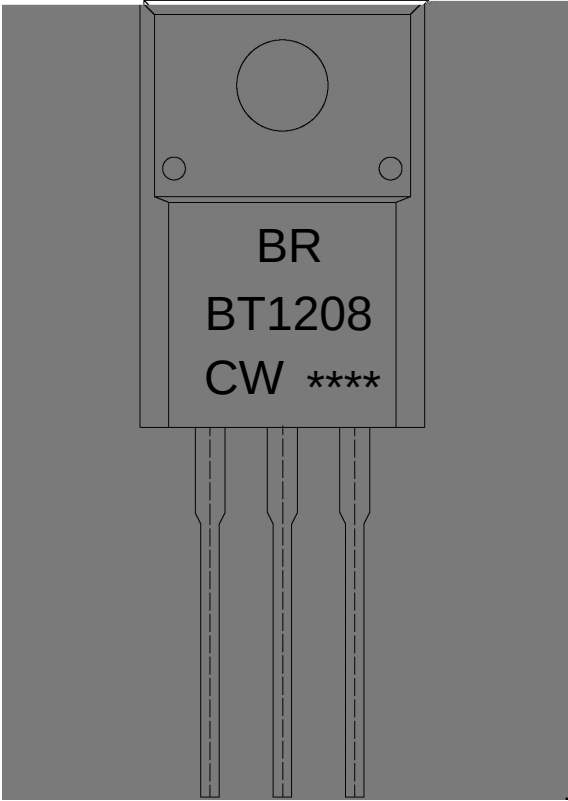


: 5 , . > // x E g U O J ´ o ž

Electrical Characteristic Curve



, M y f / Marking Instructions



^a ¢ y
(8 y , [W A
(: y ° Z W A
) = y - : ã W A
 y Ÿ D Z W A k š Ÿ D Z J

Note:
BR: Company Code
BT1208: Product Type Code
CW: I_{GT} Bracket code
****: Lot No. Code, code change with Lot No


G PD t ... • Ž Ć (x /) / Temperature Profile for Dip Soldering(Pb-Free)

^a Ć y

1o• Ä ½ “† 25 ½150 - k ž • 60 ½90sec;

2o• Q > “† 255 r5 - k ž • 4 Ò 5 r0.5sec;

3o•D N ò i Ò 0 , † 2 ½10 - /sec.

Note:

1.Preheating:25~150 - , Time:60~90sec.

2.Peak Temp.:255 r5 - , Duration:5 r0.5sec.

3. Cooling Speed: 2~10 - /sec.

ÂD /Cã p ¯ »] / Resistance to Soldering Heat Test Conditions

“† y 270 r5 -

ž • y 10 r1 sec.

Temp.:270±5

Time:10±1 sec

G P á / Packaging SPEC.

• ^ x / BULK

Package Type
7>û ~ E

Units ;>û !H

Dimension ;>û p .